TE Internal #: 146839-3

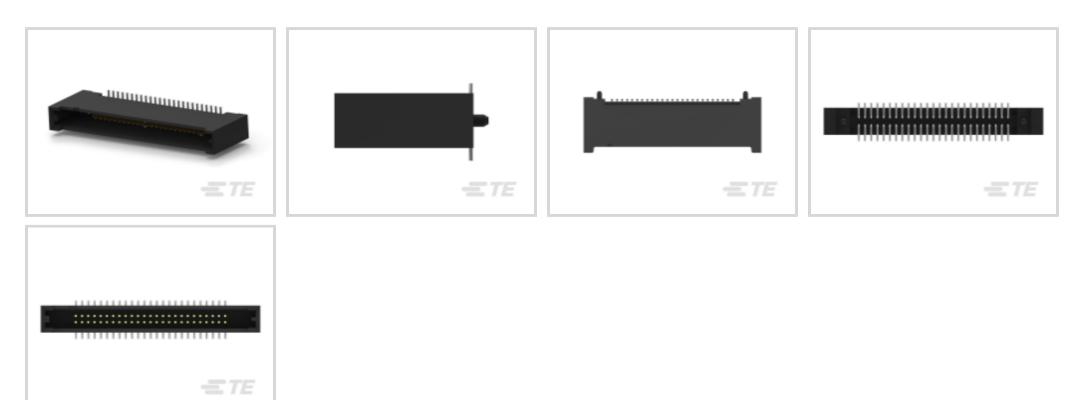
Surface Mount, Staggered Contacts, Vertical, CompactFlash

Connectors

View on TE.com >



Connectors > PCB Connectors > Memory Card Connectors > CompactFlash Connectors



Termination Method to PCB: Surface Mount

Contact Layout: **Staggered**PCB Mount Orientation: **Vertical**

Features

Product Type Features

Connector & Contact Terminates To	Printed Circuit Board
Connector System	Cable-to-Board
Configuration Features	
Number of Positions	50
Number of Rows	2
PCB Mount Orientation	Vertical
Body Features	
Primary Product Color	Black
Connector Profile	Low
Contact Features	
Contact Current Rating (Max)	.5 A
Contact Underplating Material	Nickel
Contact Mating Area Plating Material	Gold (Au)
Contact Base Material	Brass
PCB Contact Termination Area Plating Material	Tin
Contact Mating Area Plating Material Thickness	.762 μm[30 μin]



Contact Layout	Staggered
Termination Features	
Termination Method to PCB	Surface Mount
Mechanical Attachment	
Connector Mounting Type	Board Mount
Housing Features	
Housing Material	LCP
Centerline (Pitch)	1.27 mm[.05 in]
Operation/Application	
Assembly Process Feature	Vacuum Tape
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Method	Box & Tube, Tube

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	有害物质含量符合标准要求 No Restricted Substance(s) Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2025 (250) Candidate List Declared Against: JUNE 2025 (250) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these



limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Customers Also Bought





















Documents



Product Drawings

CF HDR,SMT,50P,VERT,TYPE 1,LEAD FREE

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_146839-3_F.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_146839-3_F.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_146839-3_F.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications

COMPACT FLASH CARD, 1.27mm(.050") PITCH

English

Product Specification

English

Agency Approvals

Agency Approval Document

English